

C1210C225M4VACTU

Aliases (C1210C225M4VAC7800) SMD Comm Y5V, Ceramic, 2.2 uF, 20%, 16 VDC, Y5V, SMD, MLCC, General Purpose, Class III, 1210, 1.5 mm



Click here for the 3D model.

General Information	
Series	SMD Comm Y5V
Style	SMD Chip
Description	SMD, MLCC, General Purpose, Class III
Features	Class III
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	105 mg
Shelf Life	78 Weeks
MSL	1

7% Loss/Decade Hour: Referee

Time is 1000 Hours

45.5 MOhms

	Specifications	
1210	Capacitance	2.2 uF
3.2mm +/-0.2mm	Measurement Condition	120 Hz 0.5Vrms
2.5mm +/-0.2mm	Tolerance	20%
1.85mm +/-0.20mm	Voltage DC	16 VDC
1.5mm MIN	Dielectric Withstanding Voltage	40 VDC
0.5mm +/-0.25mm	Temperature Range	-30/+85°C
	Temp. Coefficient	Y5V
	Capacitance Change with	+22%/-82%, 120Hz 0.5Vrms
T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC Applied (TCC)	
2000	Dissipation Factor	7% 120 Hz 0.5Vrms

Aging Rate

Insulation Resistance

Chip Size L W Т s в

Packaging Specifications Packaging

Dimensions

Generated 05/04/2025

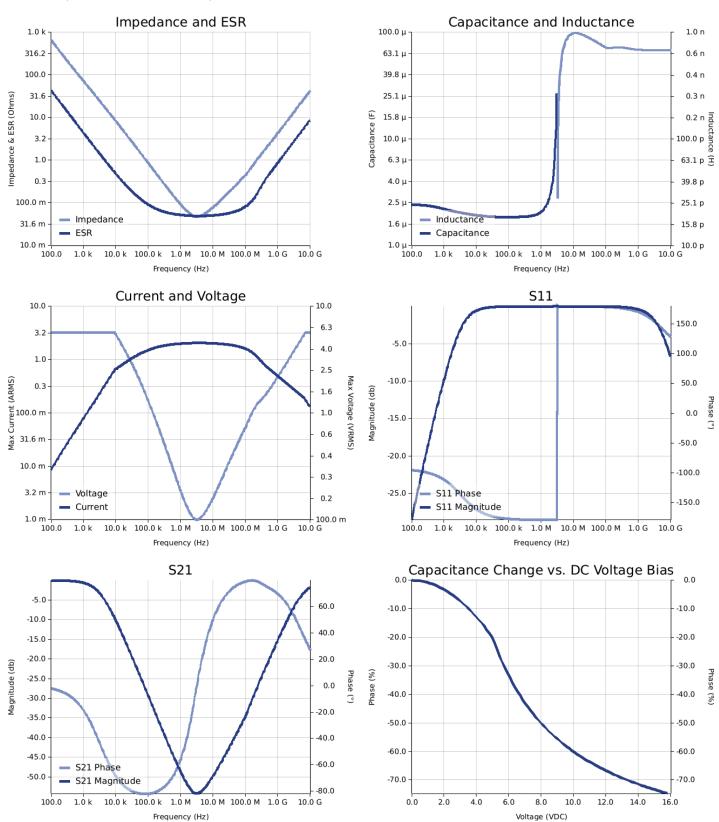
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Packaging Quantity	2000	



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Simulations

For the complete simulation environment please visit K-SIM.





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These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.

- The ESR used for hipple klipple current younge vs. requericy plots is the ESR at an bient temperature.
 The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
 The effects shown herein are based on measured data from a multiple part sample of the parts in question.
 Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.
 The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages and the part of the parts of the part of the
- generated at any other harmonics. Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.